



US00D421967S

United States Patent [19]
Oba et al.

[11] **Patent Number: Des. 421,967**
[45] **Date of Patent: ** Mar. 28, 2000**

[54] **SEMICONDUCTOR ELEMENT**

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Tokyo, Japan

[73] Assignee: **Sony Corporation**, Tokyo, Japan

[**] Term: **14 Years**

[21] Appl. No.: **29/083,237**

[22] Filed: **Feb. 6, 1998**

[30] **Foreign Application Priority Data**

Aug. 6, 1997 [JP] Japan 9-64173

[51] **LOC (6) Cl.** **13-03**

[52] **U.S. Cl.** **D13/182**

[58] **Field of Search** D13/102, 105,
D13/107, 114, 117; 174/521; 361/679, 728,
736, 737, 742, 752, 802; 439/328, 377

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Primary Examiner—Brian N. Vinson

Attorney, Agent, or Firm—Foley & Lardner

[57] **CLAIM**

The ornamental design for a semiconductor element, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a semiconductor element showing our new design;

FIG. 2 is a top plan view thereof;

FIG. 3 is a left side elevational view thereof;

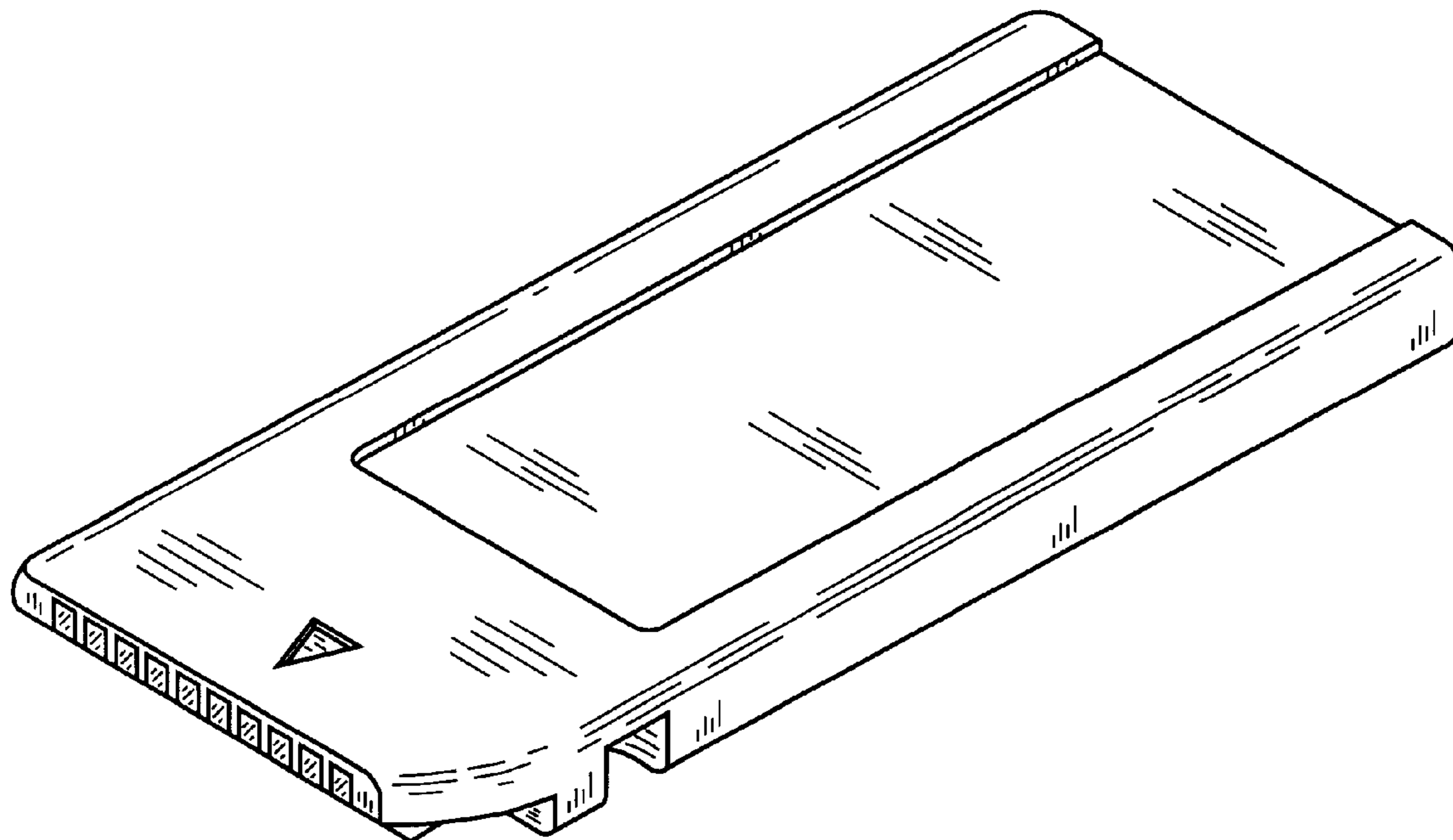
FIG. 4 is a front elevational view thereof;

FIG. 5 is a bottom plan view thereof;

FIG. 6 is a right side elevational view thereof; and,

FIG. 7 is a rear elevational view thereof.

1 Claim, 2 Drawing Sheets



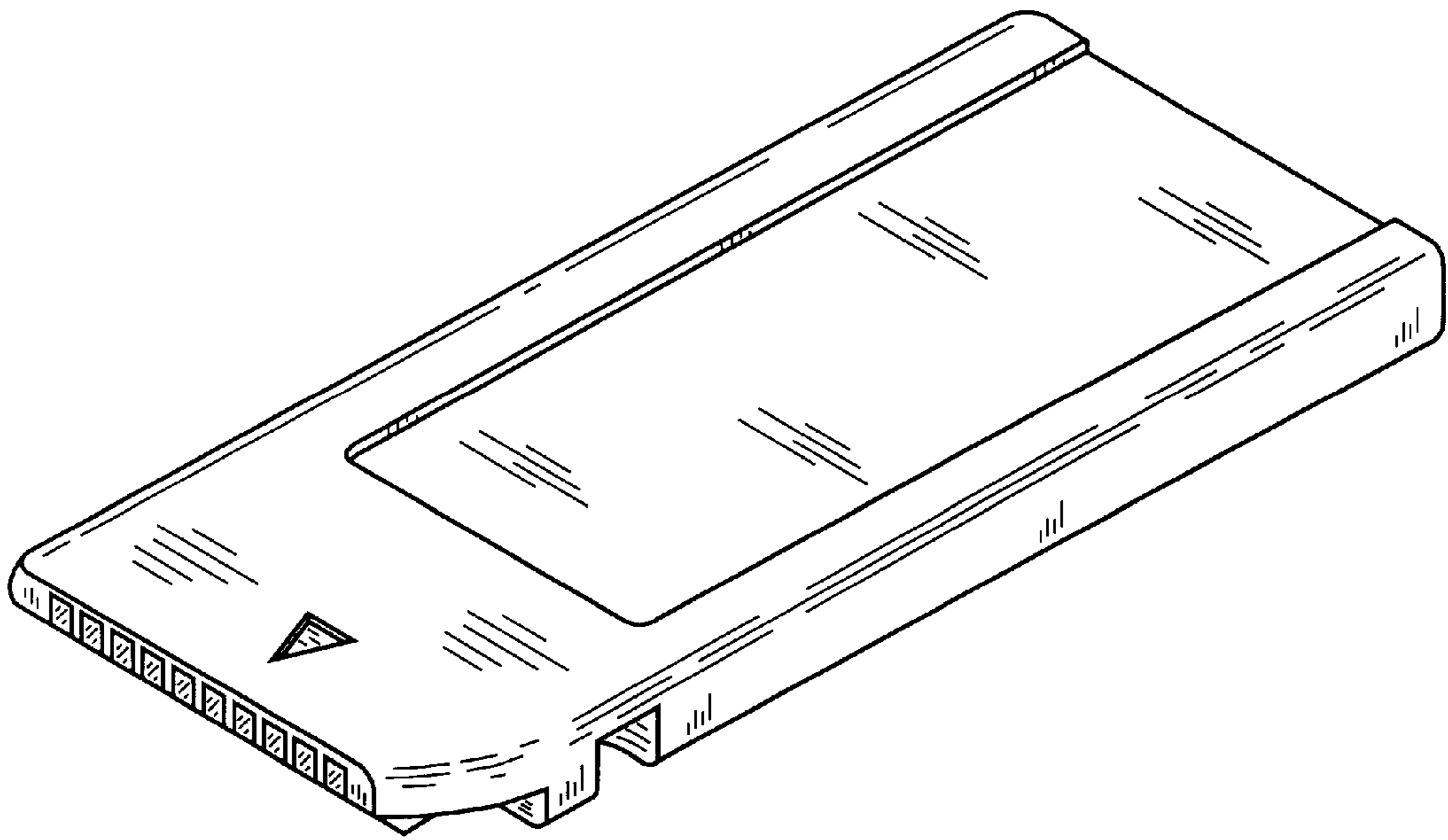


FIG. 1

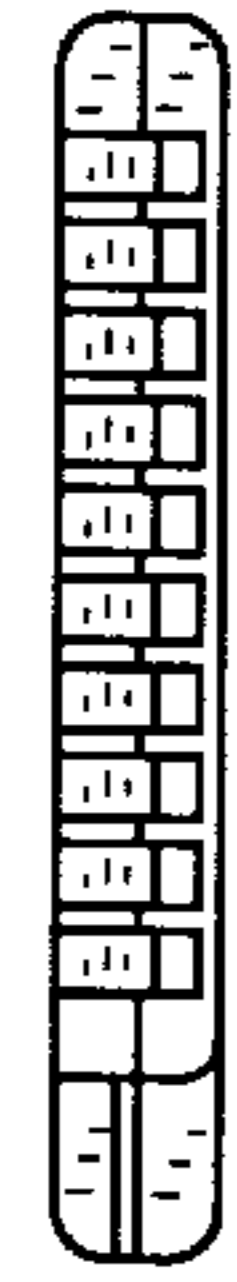


FIG. 2

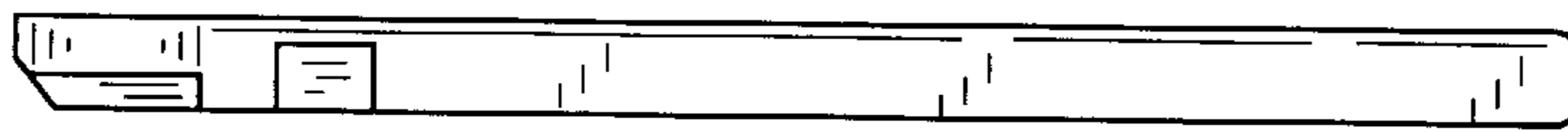


FIG. 3

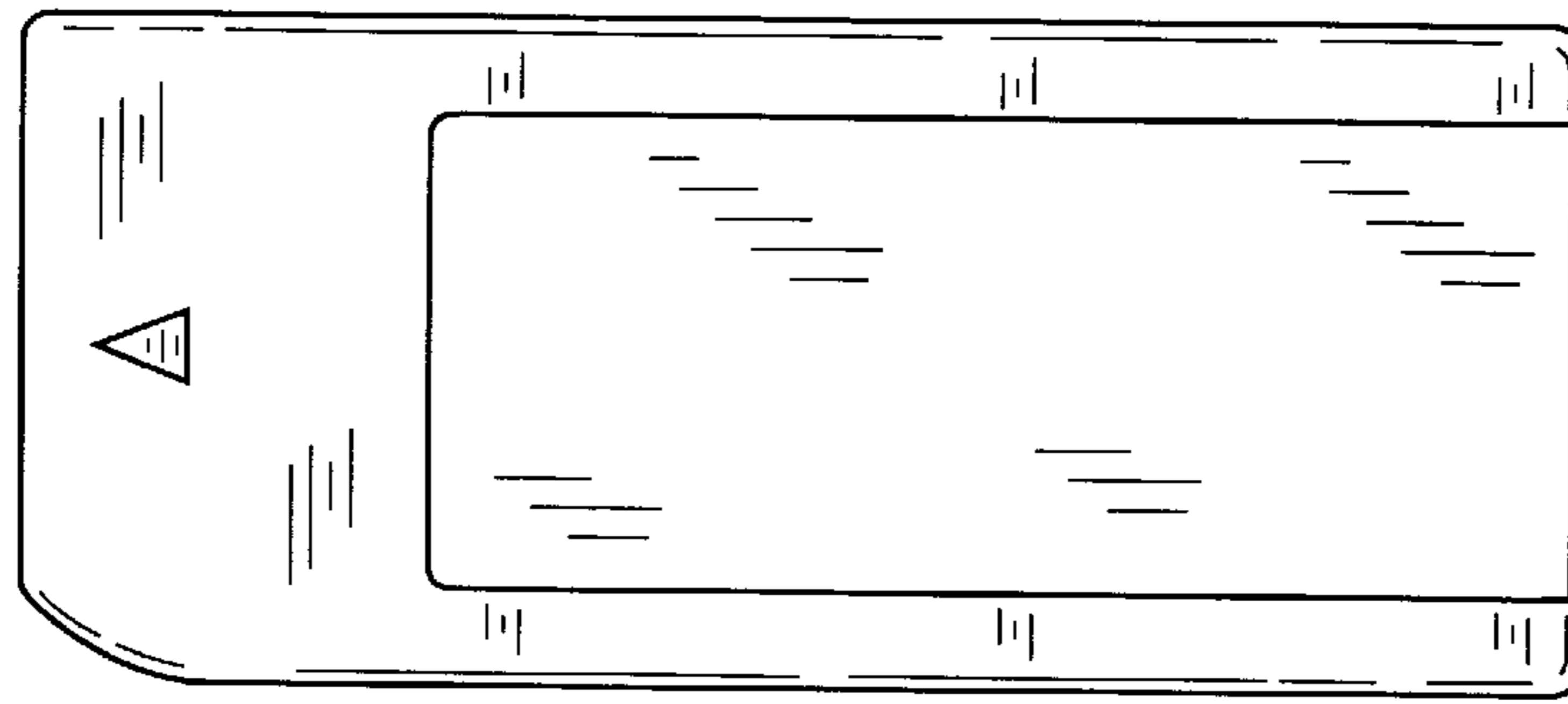


FIG. 4

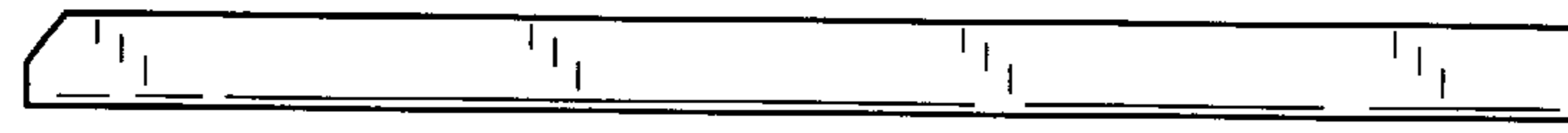


FIG. 5

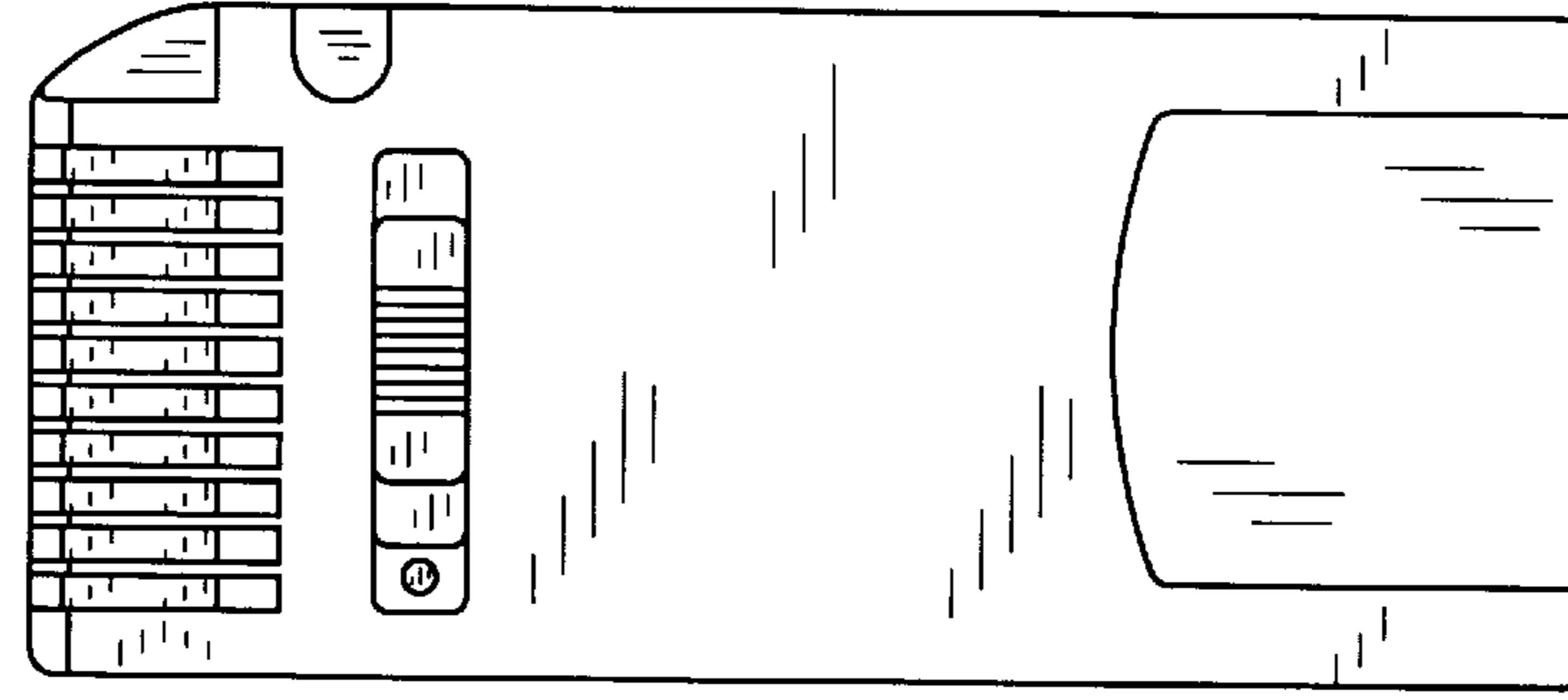


FIG. 6



FIG. 7